

REVISIONS																			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED																
M	Changes IAW NOR 5962-R195-93, 5962-R266-94, and 5962-R102-96. Entire document redrawn.	96-08-02	R. MONNIN																
N	Remove CAGE codes 23223 and 64762. Changes to table I.	98-06-22	K. A. Cottongim																
<p>THE ORIGINAL FIRST PAGE OF THIS DRAWING HAS BEEN REPLACED.</p> <p>CURRENT CAGE CODE 67268</p>																			

REV																			
SHEET																			
REV																			
SHEET																			
REV STATUS OF SHEETS				REV	N	N	N	N	N	N	N	N	N	N	N	N	N	N	
				SHEET	1	2	3	4	5	6	7	8	9	10	11	12	13	14	

PMIC N/A <div style="text-align: center;"> STANDARD MICROCIRCUIT DRAWING </div> <p style="text-align: center; font-size: small;">THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE</p> <p style="text-align: center; font-size: small;">AMSC N/A</p>	PREPARED BY C. R. Jackson CHECKED BY William E. Shoup APPROVED BY N. A. Hauck DRAWING APPROVAL DATE 80-12-22 REVISION LEVEL N	<div style="text-align: center;"> DEFENSE SUPPLY CENTER COLUMBUS P. O. BOX 3990 COLUMBUS, OHIO 43216-5000 </div> <div style="text-align: center; margin-top: 20px;"> MICROCIRCUIT, HYBRID, LINEAR, OPERATIONAL AMPLIFIER, THICK FILM </div> <table border="1" style="width: 100%; border-collapse: collapse; margin-top: 10px;"> <tr> <td style="width: 15%;">SIZE A</td> <td style="width: 35%;">CAGE CODE 14933</td> <td style="width: 50%; text-align: center;">80013</td> </tr> <tr> <td colspan="3" style="text-align: center;">SHEET 1 OF 9</td> </tr> </table>	SIZE A	CAGE CODE 14933	80013	SHEET 1 OF 9		
SIZE A	CAGE CODE 14933	80013						
SHEET 1 OF 9								

DSCC FORM 2231

APR 97

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

5962-E402-98

 9004708 0037057 527

1. SCOPE

1.1 Scope. This drawing documents one product assurance class, class H (high reliability) and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN).

1.2 PIN. The PIN shall be as shown in the following example:



1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	MSK 0032B	Operational amplifier

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
Z	See figure 1	12	Can

1.2.3 Lead finish. The lead finish shall be as specified in MIL-PRF-38534.

1.3 Absolute maximum ratings.

Supply voltage range	±18 V dc maximum
Input voltage range	±18 V dc
Maximum power dissipation (P _D), T _A = +25°C	1.5 W <u>1/</u> <u>2/</u>
Storage temperature range	-65°C to +150°C
Lead temperature (soldering, 10 seconds)	+300°C
Junction temperature (T _J)	+150°C

1.4 Recommended operating conditions.

Supply voltage (V _S)	±15 V dc
Ambient operating temperature range (T _A)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbook. The following specification, standards, and handbook form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38534 - Hybrid Microcircuits, General Specification for.

- 1/ No heat sink.
2/ Derate at 10 mW per °C.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 2

DSCC FORM 2234
APR 97

■ 9004708 0037058 463 ■

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Methods and Procedures for Microelectronics.
MIL-STD-973 - Configuration Management.
MIL-STD-1835 - Microcircuit Case Outlines.

HANDBOOK

DEPARTMENT OF DEFENSE

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbook are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item performance requirements for device class H shall be in accordance with MIL-PRF-38534. Compliance with MIL-PRF-38534 may include the performance of all tests herein or as designated in the device manufacturer's Quality Management (QM) plan or as designated for applicable device class. Therefore, the tests and inspections herein may not be performed for applicable device class (see MIL-PRF-38534). Furthermore, the manufacturers may take exceptions or use alternate methods to the tests and inspections herein and not perform them. However, the performance requirements as defined in MIL-PRF-38534 shall be met for the applicable device class. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38534 and herein.

3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.2 herein and on figure 1

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 2.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full specified operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking of device(s). Marking of device(s) shall be in accordance with MIL-PRF-38534. The device shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's vendor similar PIN may also be marked as listed in QML-38534.

3.6 Data. In addition to the general performance requirements of MIL-PRF-38534, the manufacturer of the device described herein shall maintain the electrical test data (variables format) from the initial quality conformance inspection group A lot sample, for each device type listed herein. Also, the data should include a summary of all parameters manually tested, and for those which, if any, are guaranteed. This data shall be maintained under document revision level control by the manufacturer and be made available to the preparing activity (DSCC-VA) upon request.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 3

DSCC FORM 2234
APR 97

■ 9004708 0037059 3TT ■

3.7 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in QML-38534 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38534 and the requirements herein.

3.8 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38534 shall be provided with each lot of microcircuits delivered to this drawing.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38534 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38534. The following additional criteria shall apply:

- a. Preseal burn-in test, method 1030 of MIL-STD-883. (optional for class H)
 - (1) Test condition C or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1030 of MIL-STD-883.
 - (2) T_A as specified in accordance with table I of method 1015 of MIL-STD-883.
- b. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
 - (2) T_A as specified in accordance with table I of method 1015 of MIL-STD-883.
- c. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 4

DSCC FORM 2234
APR 97

■ 9004708 0037060 011 ■

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 1/ $-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Input offset voltage	V_{IO}	$R_L = 100\text{ k}\Omega, V_{IN} = 0\text{ V}$	1	01		5.0	mV
			2,3			10.0	
Input voltage range 2/	V_{CM}		1,2,3	01	± 10		V
Input offset current	I_{IO}	$V_{IN} = 0\text{ V}$	1	01		0.025	nA
			2,3			25	
Input bias current	I_{IB}	$V_{IN} = 0\text{ V}$	1	01		0.1	nA
			2,3			50	
Supply current	I_{CC}	$I_O = 0\text{ mA}, T_A = +25^{\circ}\text{C}$	1	01		20	mA
Supply voltage rejection ratios	$SVRR(\pm)$	$\pm 5\text{ V} \leq V_S \leq \pm 20\text{ V}$	4,5,6	01	50		dB
Large signal voltage 2/ 3/ gain	$A_{VS}(\pm)$	$R_L = 1\text{ k}\Omega, V_{OUT} = \pm 10\text{ V}$	4	01	48		dB
			5, 6		45		
Input voltage common-mode rejection ratio	CMRR	$\Delta V_{IN} = \pm 10\text{ V}$	4,5,6	01	50		dB
Input offset voltage temperature coefficient	$\Delta V/\Delta T$		1,2,3	01		50	$\mu\text{V}/^{\circ}\text{C}$
Output voltage swing (maximum)	V_{OP}	$R_L = 1\text{ k}\Omega$	1,2,3	01	± 10		V
Voltage gain	A_V	$R_L = 1\text{ k}\Omega, V_{OUT} = \pm 10\text{ V}, f = 1\text{ kHz}$	4,5,6	01	57		dB
Slew rate	SR	$R_L = 1\text{ k}\Omega, A_V = +1, \Delta V_{IN} = 20\text{ V}, T_A = +25^{\circ}\text{C}$	4	01	350		V/ μs
Small signal rise time	t_r	$A_V = +1, R_L = 1\text{ k}\Omega, T_A = +25^{\circ}\text{C}$	9	01		20	ns
Small signal delay time	t_d	$A_V = +1, R_L = 1\text{ k}\Omega, \Delta V_{IN} = 1\text{ V}, T_A = +25^{\circ}\text{C}$	9	01		25	ns
Settling time to 1 percent 2/ of final value	t_{set}	$A_V = -1, R_L = 1\text{ k}\Omega, \Delta V_{IN} = 20\text{ V}, T_A = +25^{\circ}\text{C}$	9	01		0.5	μs

1/ $V_S = \pm 15.0\text{ V dc.}$

2/ Parameter shall be guaranteed to the limits specified in table I for all lots not specifically tested.

3/ Subgroups 5 and 6 shall be tested as part of device initial characterization and after design and process changes. Parameter shall be guaranteed to the limits specified for subgroups 5 and 6 for all lots not specifically tested.

STANDARD
MICROCIRCUIT DRAWING
DEFENSE SUPPLY CENTER COLUMBUS
COLUMBUS, OHIO 43216-5000

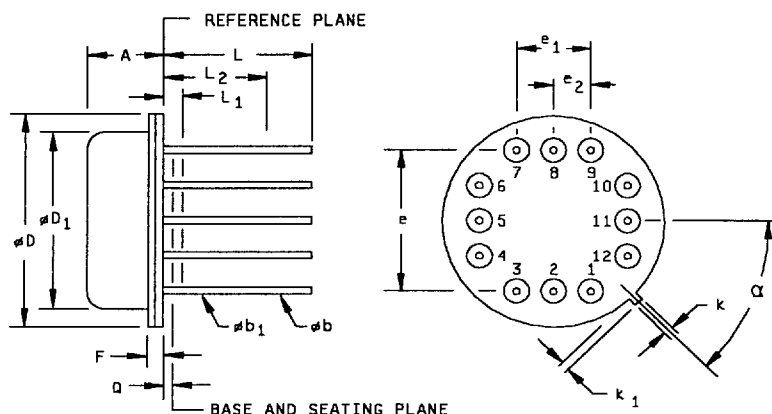
SIZE
A

80013

REVISION LEVEL
N

SHEET
5

Case outline Z.



Symbol	Inches		Millimeters		Notes	Symbol	Inches		Millimeters		Notes
	Min	Max	Min	Max			Min	Max	Min	Max	
A	0.130	0.181	3.30	4.60		F	0.022	0.030	0.56	0.76	
ϕb	0.016	0.019	0.41	0.48	2, 6	k	0.026	0.036	0.66	0.91	
ϕb_1	0.016	0.021	0.41	0.53	2, 6	k ₁	0.026	0.036	0.66	0.91	3
ϕD	0.595	0.610	15.11	15.49		L	0.500	0.560	12.70	14.22	2
ϕD_1	0.545	0.555	13.84	15.37		L ₁	----	0.050	----	1.27	2
e	0.400 BSC		10.16 BSC		4	L ₂	0.250	----	6.35	----	2
e ₁	0.200 BSC		5.08 BSC		4	Q	----	0.045		1.14	
e ₂	0.100 BSC		2.54 BSC		4	α	45° BSC		45° BSC		

NOTES:

1. The U.S. government preferred system of measurement is the metric SI system. However, this item was originally designed using inch-pound units of measurement. In the event of conflict between the metric and inch-pound units, the inch-pound units shall take precedence.
2. All leads ϕb applies between L₁ and L₂. ϕb_1 applies between L₂ and 0.500 (12.70 mm) from the reference plane. Diameter is uncontrolled in L₁ and beyond 0.500 (12.70 mm) from the reference plane.
3. Measured from the maximum diameter of the product.
4. Leads having a maximum diameter 0.019 (0.48 mm) measured in gauging plane 0.054 (1.37 mm) + 0.001 (0.03 mm) - 0.000 (0.00 mm) below the base plane of the product shall be within 0.007 (0.18 mm) of their true position relative to a maximum tab width.
5. The product may be measured by direct methods or by gauge.
6. All leads: Increase maximum limit by 0.003 (0.08 mm) when lead finish A is applied.

FIGURE 1. Case outline(s).

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 6

DSCC FORM 2234
APR 97

9004708 0037062 994

Device type	01
Case outline	Z
Terminal number	Terminal symbol
1	No connection
2	Output compensation
3	Balance/compensation
4	Balance/compensation
5	Inverting input
6	Noninverting input
7	No connection
8	No connection
9	No connection
10	-V _S
11	Output
12	+V _S

FIGURE 2. Terminal connections.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 7

DSCC FORM 2234
APR 97

■ 9004708 0037063 820 ■

TABLE II. Electrical test requirements.

MIL-PRF-38534 test requirements	Subgroups (in accordance with MIL-PRF-38534, group A test table)
Interim electrical parameters	
Final electrical parameters	1*, 2, 3, 4, 5, 6, 9
Group A test requirements	1, 2, 3, 4, 9
Group C end-point electrical parameters	1, 2, 3

* PDA applies to subgroup 1.

4.3 Conformance and periodic inspections. Conformance inspection (CI) and periodic inspection (PI) shall be in accordance with MIL-PRF-38534 and as specified herein.

4.3.1 Group A inspection (CI). Group A inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 7, 8, 10, and 11 shall be omitted.

4.3.2 Group B inspection (PI). Group B inspection shall be in accordance with MIL-PRF-38534.

4.3.3 Group C inspection (PI). Group C inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - (2) T_A as specified in accordance with table I of method 1005 of MIL-STD-883.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.3.4 Group D inspection (PI). Group D inspection shall be in accordance with MIL-PRF-38534.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38534.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 8

DSCC FORM 2234
APR 97

■ 9004708 0037064 767 ■

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-7603.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, P. O. Box 3990, Columbus, Ohio 43216-5000, or telephone (614) 692-0676.

6.6 Sources of supply. Sources of supply are listed in QML-38534. The vendors listed in QML-38534 have submitted a certificate of compliance (see 3.7 herein) to DSCC-VA and have agreed to this drawing.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		80013
		REVISION LEVEL N	SHEET 9

DSCC FORM 2234
APR 97

■ 9004708 0037065 6T3 ■

STANDARD MICROCIRCUIT DRAWING SOURCE APPROVAL BULLETIN

DATE: 98-06-22

Approved sources of supply for SMD 80013 are listed below for immediate acquisition only and shall be added to QML-38534 during the next revision. QML-38534 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of QML-38534.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
8001301ZA 8001301ZC	51651 51651	MSK 0032B MSK 0032B

- 1/ The lead finish shown for each PIN, representing a hermetic package, is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the Vendor to determine availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

51651

Vendor name
and address

M.S. Kennedy Corporation
8170 Thompson Road
Cicero, NY 13039-9393

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.

■ 9004708 0037066 53T ■

101269